

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Wood et al.

Serial No.: 10/666,742

Filed: September 19, 2003

For: METHODS FOR THINNING
SEMICONDUCTOR SUBSTRATES THAT
EMPLOY SUPPORT STRUCTURES
FORMED ON THE SUBSTRATES
(Amended)

Confirmation No.: 6057

Examiner: A. Ghyka

Group Art Unit: 2812

Attorney Docket No.: 2269-6095US
(03-0593.00/US)

VIA ELECTRONIC FILING
July 20, 2007

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Examiner:

This Amendment follows the Office Action of April 20, 2007, the shortened statutory period for response to which expires on July 20, 2007.

A listing of claims, in which revisions to the claims are presented, begins on page 2 of this paper; and

Remarks start at page 10 of this paper.